

Project Title Goes Here

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TYPE II STRAINED LAYER SUPERLATTICE PLANAR DIODE FABRICATION VIA THERMAL DIFFUSION OF ZINC

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Outline

- Introduction
- Type II Strained Layer Superlattice (SLS) Detectors
- Surface Leakage Current
- Sidewall Passivation and Planar Devices
- Planar Device Fabrication
- Characterization and Analysis
- Conclusion

Introduction

Motivation:

Develop MWIR and LWIR FPAs utilizing Type II Strained Layer Superlattices (SLSs) and III-V semiconductors

Passive Sensing:

- ISR
- Persistent Surveillance (Air & Space)
- Threat Warning
- Infrared Search and Track (IRST)
- Tactical Reconnaissance
- Missile Warning
- Laser Warning

Commercial Applications:

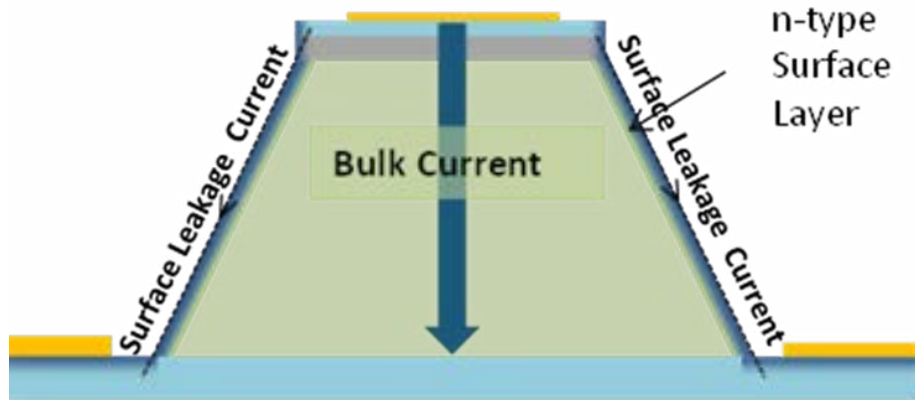
- Residential insulation and water damage inspection
- Toxic gas detection
- Non-invasive imaging in medical industry



Left: SSgt Raughton. U.S. Air Force pilot inspects the IRST Pod attached to his F-15C Eagle. January 26, 2022. USAF. <https://www.af.mil/News/Photos/i-photo/2002937019/mediaid/5785264/>

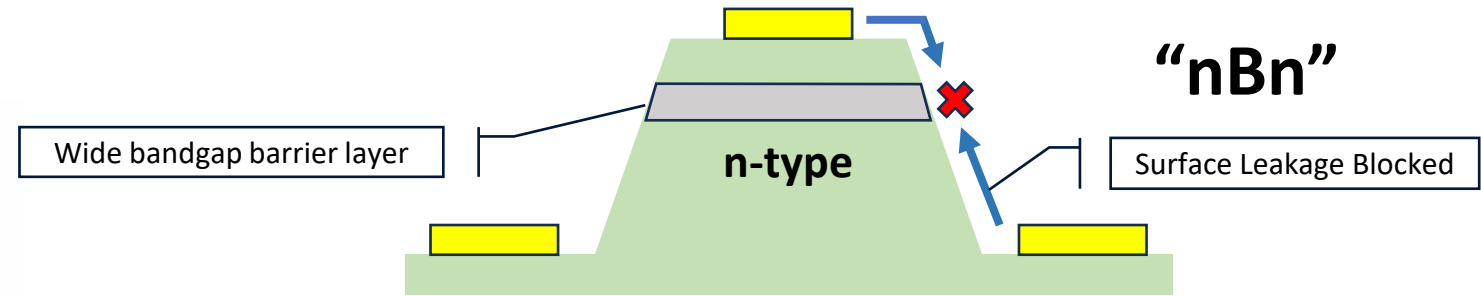
Right: *How Thermographic Inspections Work*. Energy.gov. <https://www.energy.gov/energysaver/thermographic-inspections>

Surface Leakage Current

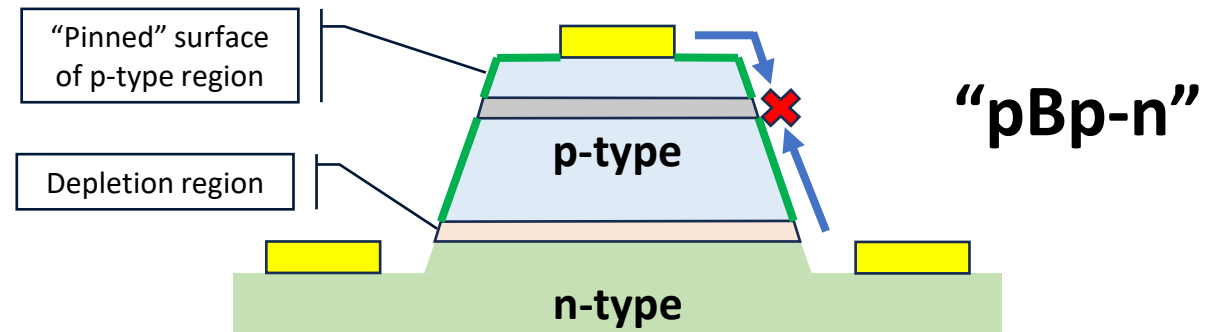


Leakage Current in pn diodes:

- **Caused by:** surface Fermi-level 'pin'-ing of the p-type region in detectors
- **Results in:** electrons along the surface moving freely between the contacts, creating a shunt



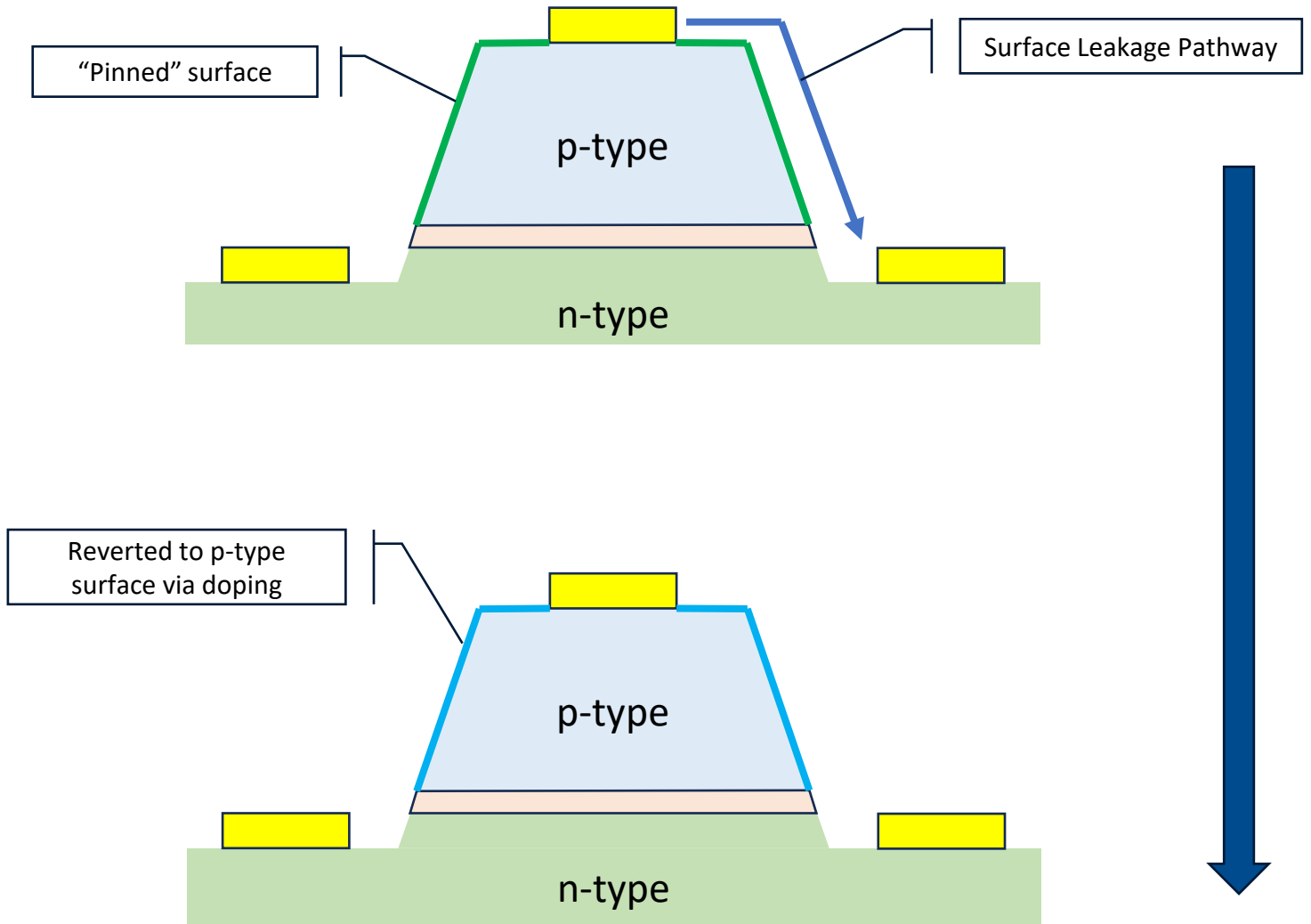
Unipolar barrier architectures using n-type layers (nBn) solve leakage current.



pBp-n detectors solve this problem, but have higher Dark Current and effectiveness of the barrier is limited in reduced mesa sizes.

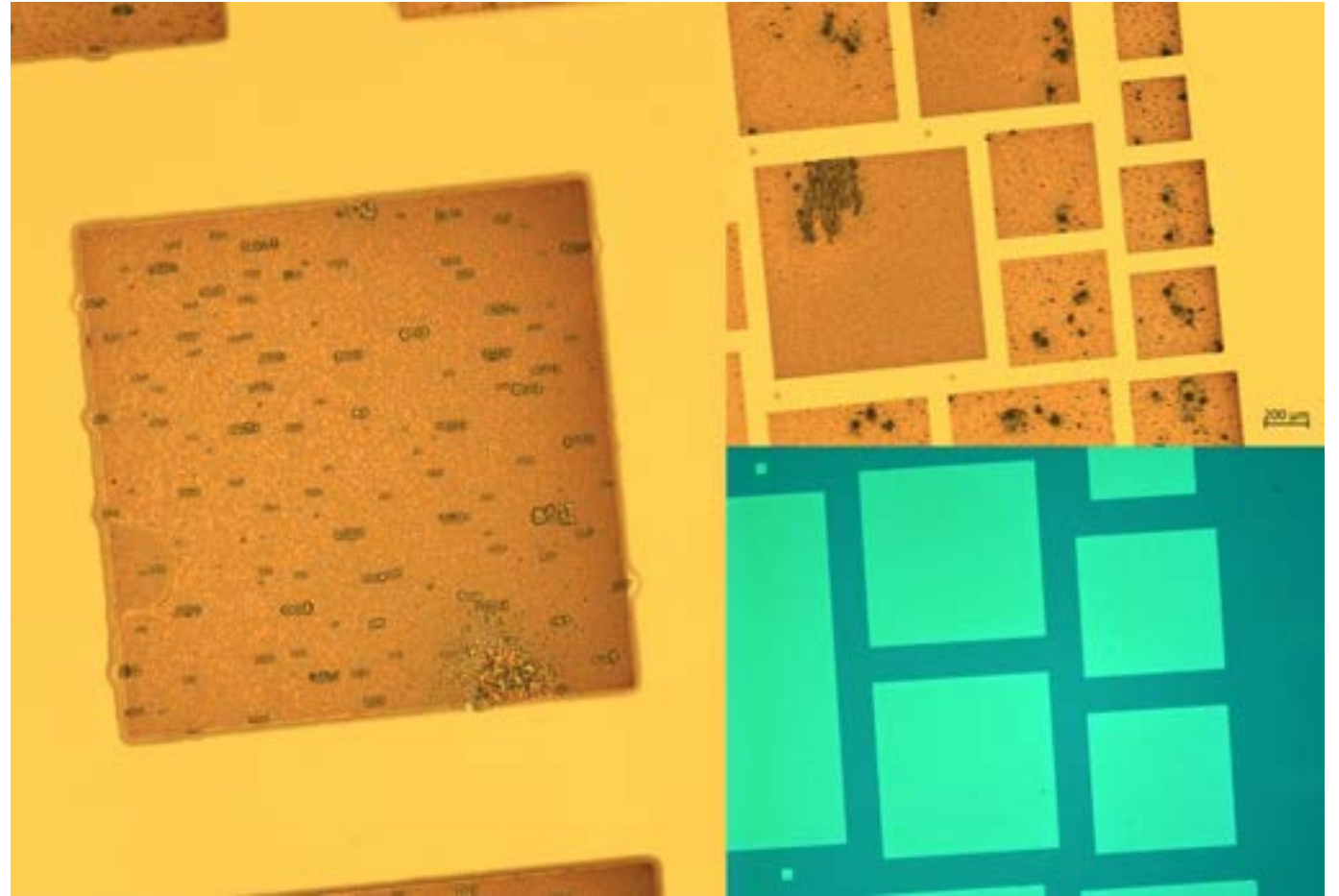
Project Goal

- **Final goal:** to passivate the “pinned” surface via p-type doping
- **Doping Process:** thermal diffusion of zinc
- **First step:** prove that zinc can dope the n-type SLS (including the “pinned” surface) p-type via thermal diffusion
- **Initial goal:** create simplified planar homojunctions with thermally diffused zinc in n-type SLS

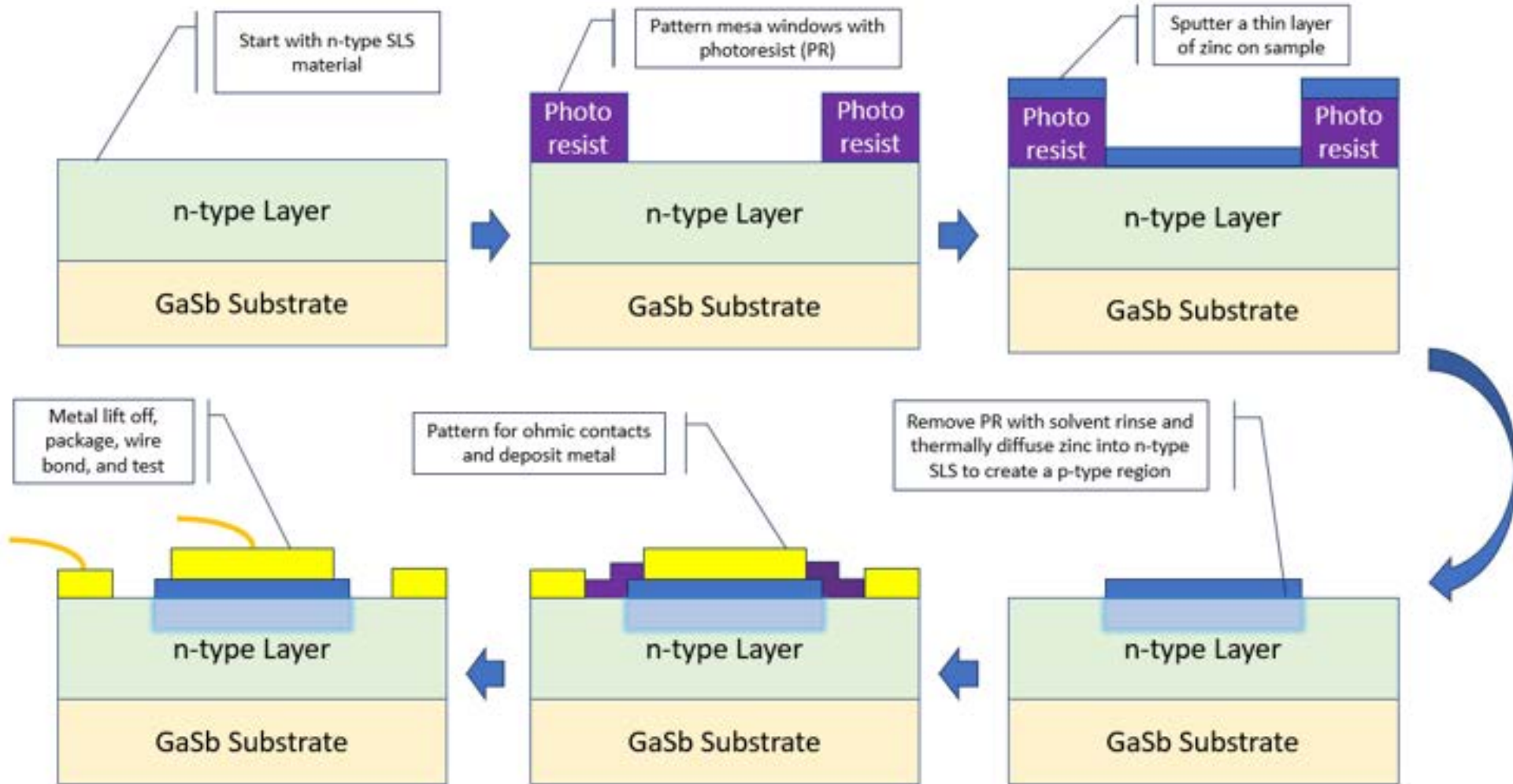


Methodology

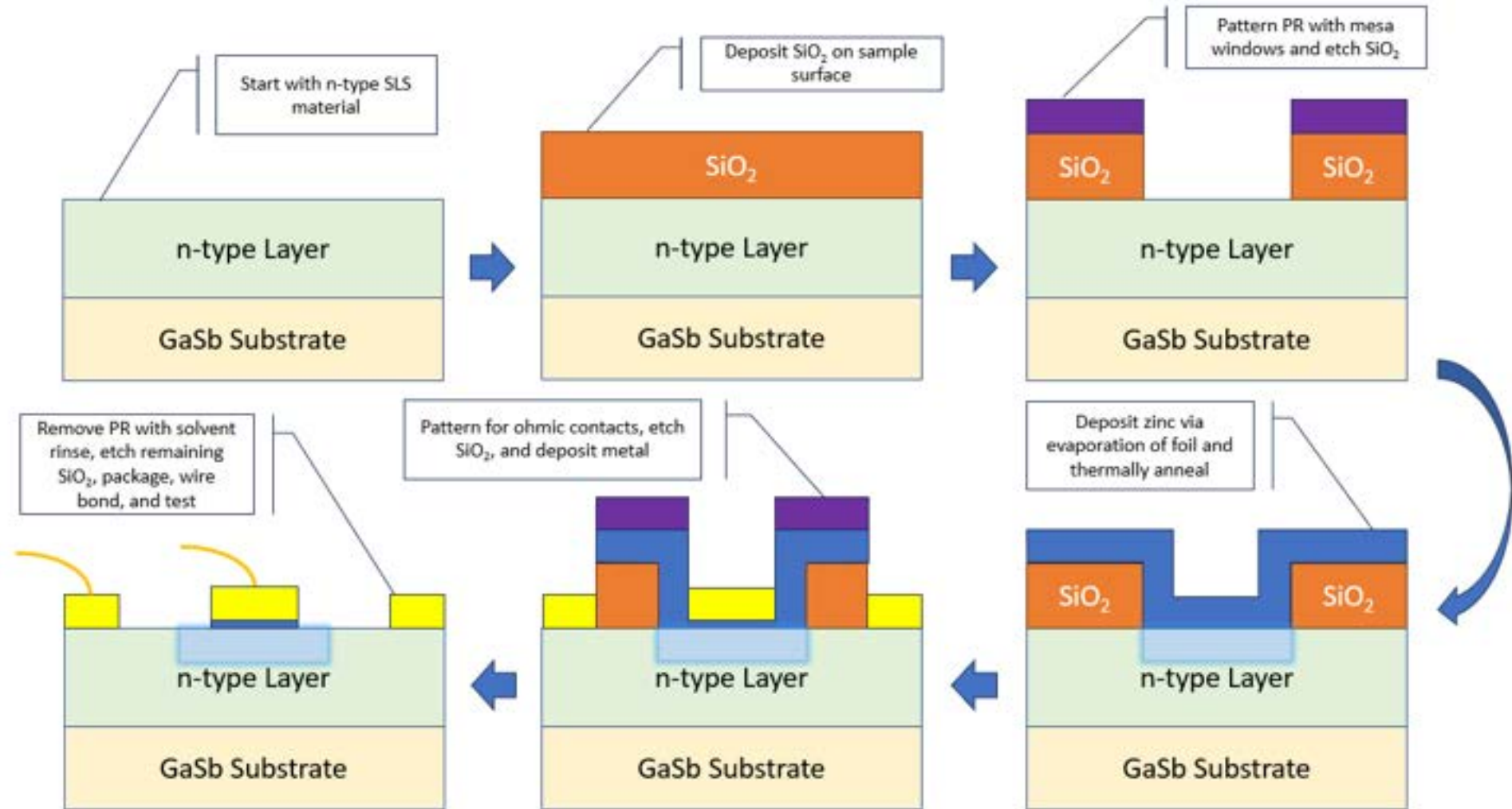
- Two types of device fabrication processes were pursued:
 - Zinc thermal evaporation
 - Zn Sputter deposition
- *pBpn* detectors were produced to serve as a control
- Electrical measurements taken for all devices included:
 - Dark current
 - Quantum Efficiency
 - Spectral Response



Planar Device Fabrication via Sputtered Zinc

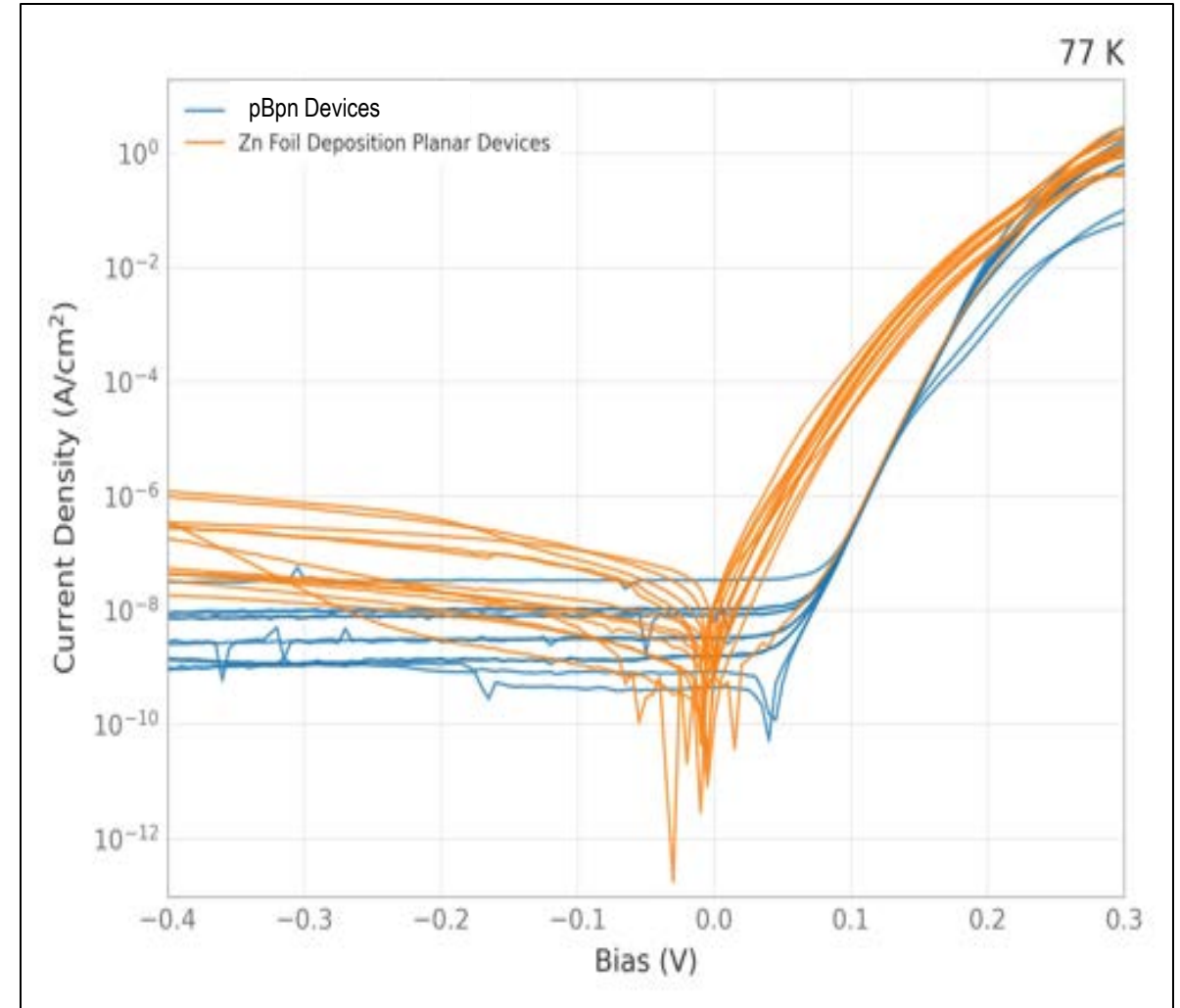


Planar Diode Fabrication via Zinc Thermal Evaporation



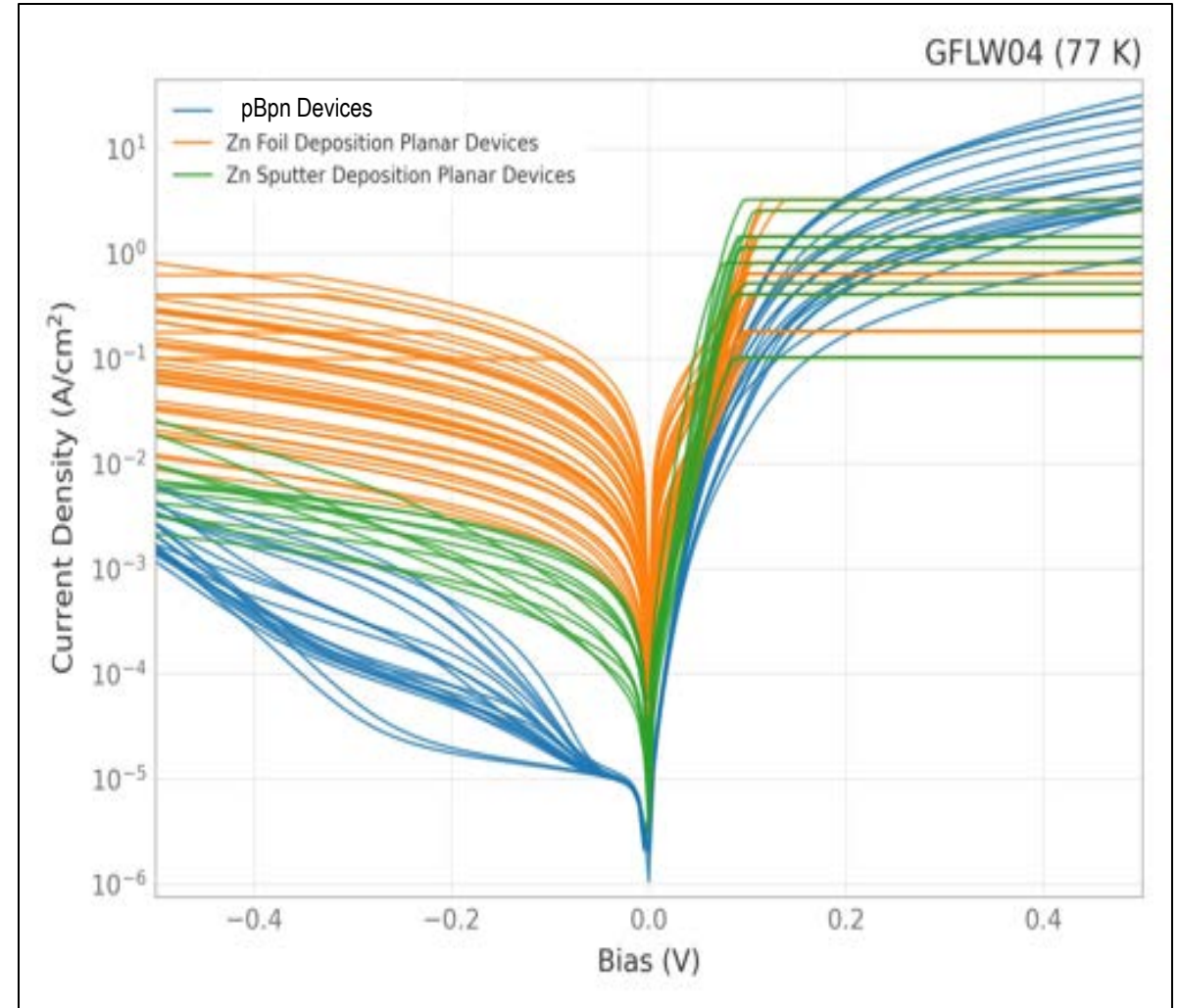
Dark Current of the MWIR Detectors

- Planar diodes were fabricated using MWIR n -type SLS and the Zn Foil Deposition process.
- Rectification of 6 orders of magnitude was achieved with the diodes from three separate samples.
- Devices from the $pBpn$ structure may still have lower dark current. The reverse bias current is below the detection floor.
- Conclusion: Evaporated zinc can dope n -type MWIR SLS material p -type and create planar diodes.

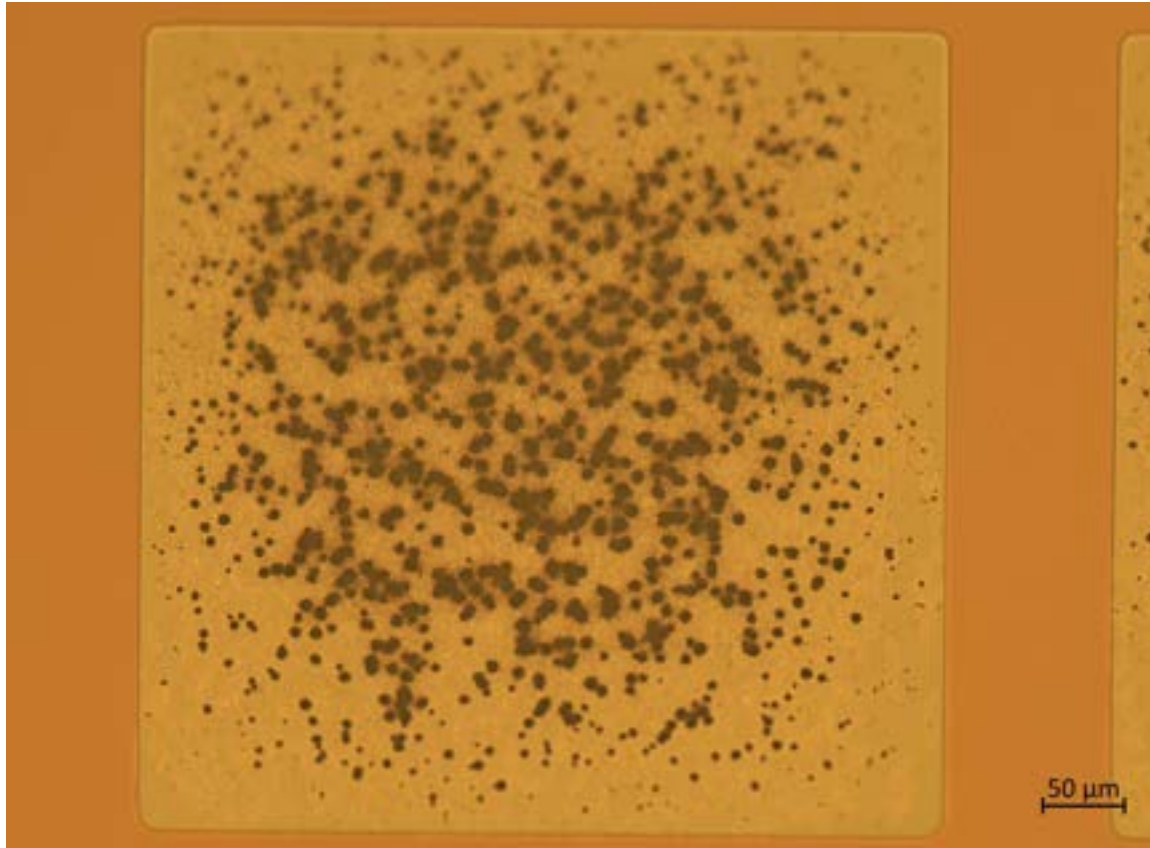


Dark Current of the LWIR Detectors

- Both thermal evaporation and sputtering resulted in planar diodes in LWIR n -type SLS.
- Zn evaporation was more repeatable, but the range of dark current values was larger.
- Zn Sputter process only worked once but produced lower dark current and had smaller range of values.
- A rectification of at least 2 orders of magnitude was achieved with both processes.
- Conclusion: Sputtered zinc can dope n -type LWIR SLS material p -type and create planar diodes. Reproducibility needs more work.



Evaporation vs Sputter Deposition

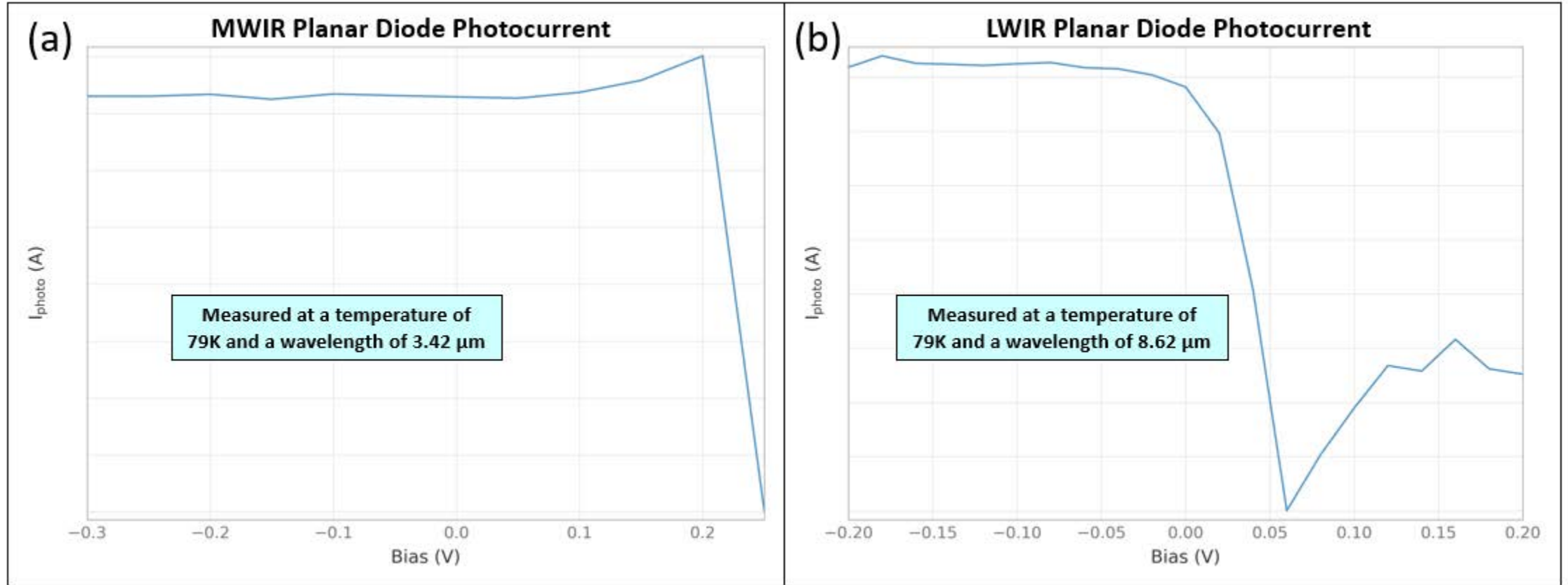


Thermal evaporation of zinc leads to nonuniform deposition pattern

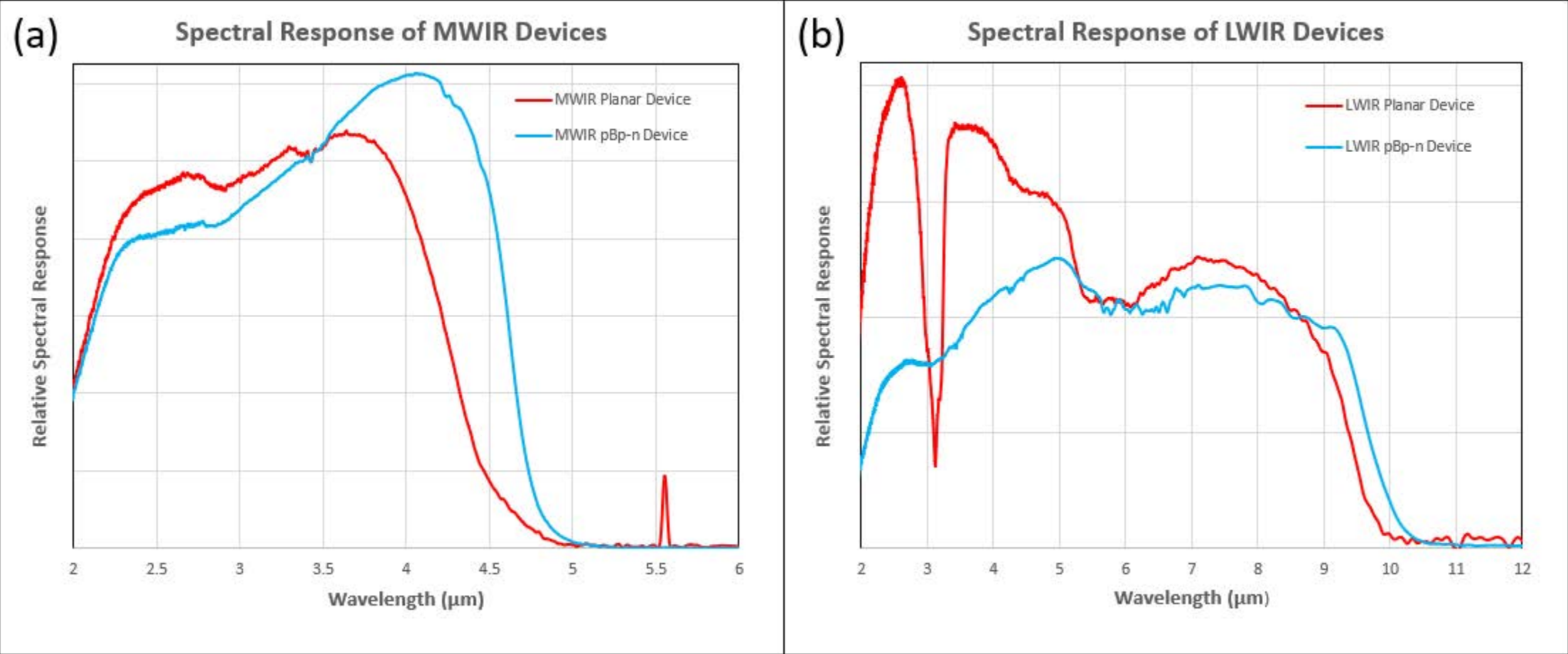


Uniformity of sputtered zinc films could decrease variations in level of doping

Photocurrent vs Bias Data



Spectral Response Data



Conclusion

- Thermal diffusion of zinc into n-type SLS material can result in diodes. This applies to both MWIR and LWIR material.
- Rectification of 6 orders of magnitude for MWIR diodes and 2 orders of magnitude for LWIR diodes was measured.
- Spectral responses were measured across the expected wavelength ranges for both the LWIR and MWIR devices, albeit with a noticeable blue shift.
- Dark current performance of planar diodes still lacks in comparison to their commercial $pBpn$ counterparts.
- Further process development can improve the consistency of planar diode fabrication.
- Most importantly, thermal diffusion of zinc has been shown to dope n -type SLS.
- Further research can now be done to dope “pinned” sidewalls of pn diodes in SLS material as a method of device passivation.

Acknowledgements

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QUESTIONS?